



Material Content Data Sheet



Halogen-Free

Sales Product Name	IRFR2407TRPBF	Issued	12. August 2021
MA#	MA005613828		
Package	PG-TO252-3-901	Weight*	334.16 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	7.201	2.15	2.15	21548	21548
leadframe	inorganic material	phosphorus	7723-14-0	0.056	0.02		169	
	non noble metal	iron	7439-89-6	0.188	0.06		563	
	non noble metal	copper	7440-50-8	187.935	56.23	56.31	562410	563142
wire	non noble metal	aluminium	7429-90-5	1.790	0.54	0.54	5358	5358
encapsulation	organic material	carbon black	1333-86-4	0.258	0.08		771	
	plastics	epoxy resin	-	16.496	4.94		49365	
	inorganic material	silicondioxide	60676-86-0	112.120	33.55	38.57	335527	385663
leadfinish	non noble metal	tin	7440-31-5	1.533	0.46	0.46	4588	4588
solder	non noble metal	tin	7440-31-5	0.132	0.04		394	
	noble metal	silver	7440-22-4	0.165	0.05		493	
	non noble metal	lead	7439-92-1	6.287	1.88	1.97	18814	19701
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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